


**PATENT APPLICATION FORM /
BORANG PERMOHONAN PATEN**

 Innovation and Commercialisation Centre (ICC)
 Pusat Inovasi dan Pengkomersilan (ICC)
 Universiti Putra Malaysia

Tel : 03-8947 2055 Faks : 03-8947 2059

Note : * You are required to read about IPR before submitting your application for approval. Please visit the following websites:

Nota Anda dikehendaki mendapatkan maklumat mengenai IPR sebelum memajukan permohonan ke pejabat ICC.

Sila lawat ke laman berikut:

<http://www.wipo.int/patentscope/en/patents.htm>

http://www.myipo.gov.my/index.php?option=com_content&task=view&id=12&Itemid=7

Part A / Bahagian A
For Office Use Only:
Ref. No:

1. Source of fund and Cluster / Geran Penyelidikan dan Kelompok: [√ or/atau ■]

<u>Source of fund / Geran Penyelidikan</u>	<u>Cluster / Kelompok</u>
<input type="checkbox"/> IRPA grant	<input type="checkbox"/> Agriculture
<input type="checkbox"/> Fundamental grant	<input type="checkbox"/> Food
<input type="checkbox"/> Science fund	<input type="checkbox"/> Health
<input type="checkbox"/> Techno fund	<input type="checkbox"/> Science, Technology and Engineering
<input type="checkbox"/> Other	<input type="checkbox"/> Forestry and Environment
	<input type="checkbox"/> Social Sciences

2. Title of invention / Tajuk rekacipta: _____

3. Project Leader / Ketua Projek : _____

 4. Name of Inventor(s) /
Nama Perekacipta: _____

 5. Department/Laboratory /
Jabatan/Laboratori: _____

 6. Faculty/Institution/Academy /
Fakulti/Institut/Akademi: _____

7. E-mail / E-mel: _____

8. Telephone / telefon: _____

9. Fax / faks: _____

Part B / Bahagian B :

Instruction: Please submit this form together with the patent specification as per the format given below. Each section need to be submitted or else the application will be considered as incomplete.

Arahan Sila hantar borang ini bersama dengan Spesifikasi Paten seperti format di bawah. Setiap seksyen perlu disertakan.

Note: To download the Guideline on Writing Patent Specification, please visit the following website:
Nota: Untuk muat turun Garis Panduan Penulisan Spesifikasi Paten, sila lawat ke laman web berikut:
<http://www.icc.upm.edu.my>

Format of Patent Specification / Spesifikasi Paten

1. Field of Invention
2. Background
3. Summary
4. Description
5. Claims
6. Abstract
7. Drawing (if any)
8. Brief description of drawing

Part C / Bahagian C :

Instruction: Please visit the following website to search for prior art of your invention. Indicate your keyword used for the search in the column below.

Arahan Sila lawat ke laman di bawah untuk menjalankan carian paten. Nyatakan kata kunci yang digunakan semasa carian.

List of databases /Senarai pangkalan data: [√ or/atau]

<u>Databases / Pangkalan data</u>	<u>Keyword search</u>
1. United States Patent and Trademark Office (USPTO) <input type="checkbox"/> http://www.uspto.gov/patft/index.html	1. 2.
2. European Patent Office (EPO) <input type="checkbox"/> http://ep.espacenet.com/	1. 2.
3. Intellectual Property Office of Singapore <input type="checkbox"/> http://www.surfip.gov.sg/	1. 2.

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Signature

Date:

For Office Use Only:
Date application received: